



Low Profile and High Efficiency 868 MHz ISM Band Loop Antenna

Part No: ILA.02

Description

868 MHz ISM Band Loop Antenna

Features:

Small size antenna, low profile, and high efficiency

868 MHz ISM Band

1 dBi Peak Gain

10 x 3.2 x 0.5 mm size

SMT Compatible

RoHS & REACH Compliant



 Introduction Specification Antenna Characteristics Radiation Patterns Mechanical Drawing Packaging Antenna Integration Guide Solder Reflow Profile Changelog 			
 3. Antenna Characteristics 4 4. Radiation Patterns 5. Mechanical Drawing 6. Packaging 7. Antenna Integration Guide 8. Solder Reflow Profile 	1.	Introduction	2
 4. Radiation Patterns 5. Mechanical Drawing 6. Packaging 7. Antenna Integration Guide 8. Solder Reflow Profile 	2.	Specification	3
 5. Mechanical Drawing 6. Packaging 7. Antenna Integration Guide 8. Solder Reflow Profile 20 	3.	Antenna Characteristics	4
 6. Packaging 7. Antenna Integration Guide 8. Solder Reflow Profile 20 	4.	Radiation Patterns	8
7. Antenna Integration Guide 138. Solder Reflow Profile 20	5.	Mechanical Drawing	10
8. Solder Reflow Profile 20	6.	Packaging	11
	7.	Antenna Integration Guide	13
Changelog 21	8.	Solder Reflow Profile	20
		Changelog	21

Taoglas makes no warranties based on the accuracy or completeness of the contents of this document and reserves the right to make changes to specifications and product descriptions at any time without notice. Taoglas reserves all rights to this document and the information contained herein. Reproduction, use or disclosure to third parties without express permission is strictly prohibited.











1. Introduction



The ILA.02 is a 868 MHz ISM band antenna featuring an excellent efficiency of 60% across the band. This antenna works the best when placed at the center of the board edge. The antenna, at $10 \times 3.2 \times 0.5$ mm, is low profile and would be suitable for devices with space constraints. The ILA.02 is delivered on tape and reel and now allows M2M customers to use an omni-directional SMT antenna. The omni-directional radiation characteristics allow for excellent performance regardless of device orientation. This is especially useful for devices that are not fixed in one particular spot during use. When there is little PCB space available for antenna placement, but high performance is required, the ILA.02 is the ideal choice.

This antenna can be mounted with no performance degradation in either orientation as long as the antenna is soldered correctly via Surface mounting. Please see the integration instructions section for further detail regarding the optimum way to integrate this antenna into your device.

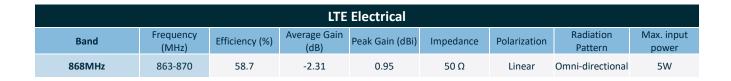
For further optimization to customer-specific device environments and for support to integrate and test this antennas performance in your device, contact your regional Taoglas Customer Services Team.

Applications:

- Automated Meter Reading (AMR)
- Radio Frequency Identification (RFID)
- Remote Monitoring
- Healthcare
- Sensing
- 868 MHz Applications



2. Specification



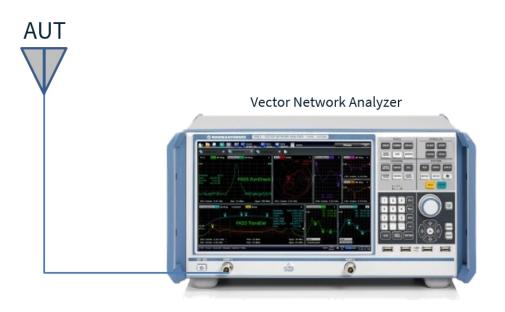
Mechanical		
Dimensions (mm)	10 x 3.2 x 0.5	
Required Space (mm)	11 x 10.4	
Material	Ceramic	
EVB Connector	SMA(F)	

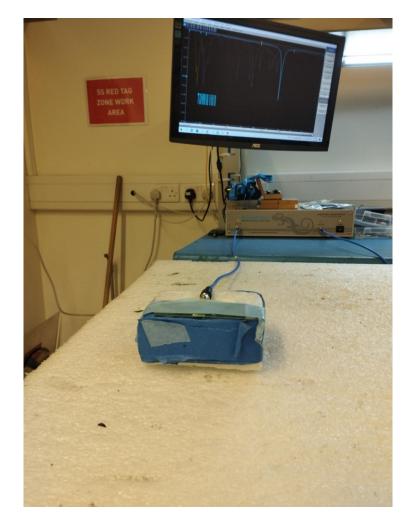
Environmental		
Temperature Range	-40°C to 85°C	
Storage Temperature	-40°C to 105°C	
Humidity	40% to 95%	
Moisture Sensitivity Level	3 (168 Hours)	



3. Antenna Characteristics

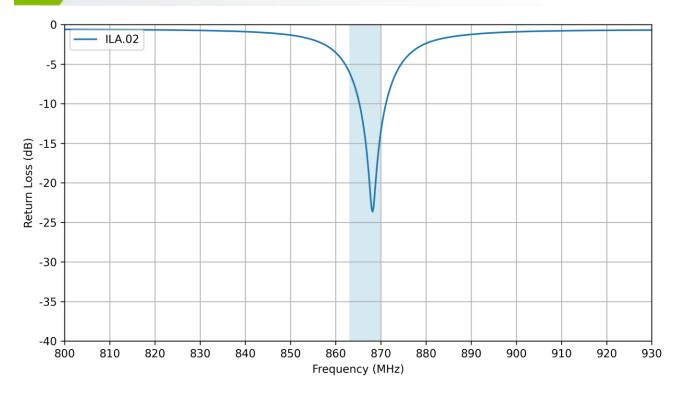
3.1 Test Setup



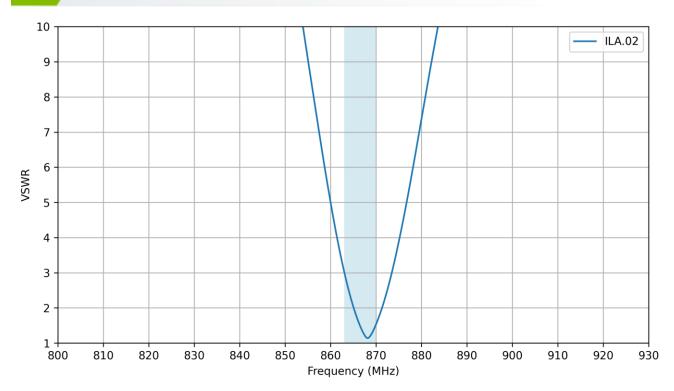




3.2 Return Loss

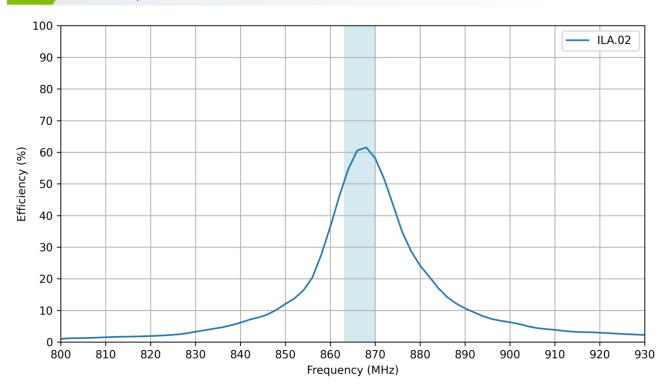


3.3 VSWR

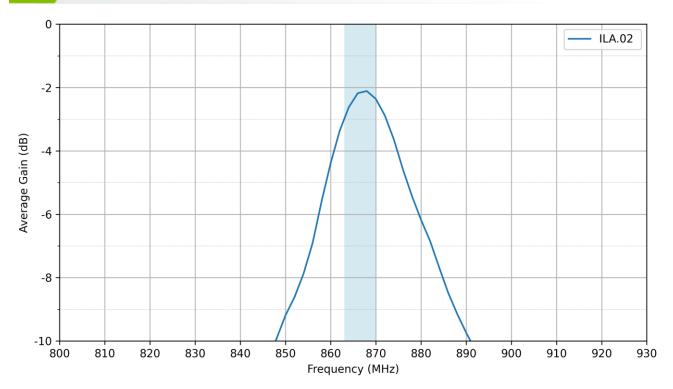




3.4 Efficiency

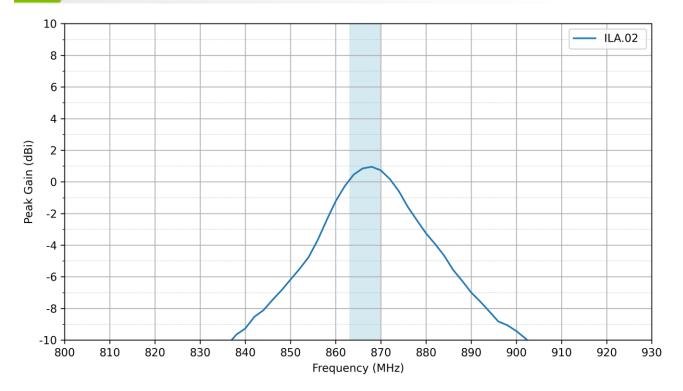


3.5 Average Gain





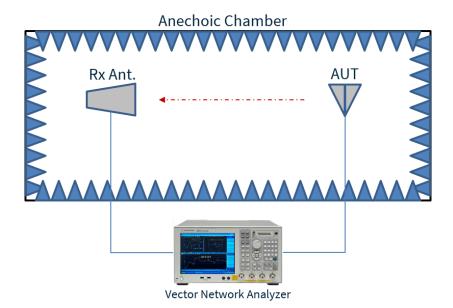
3.6 Peak Gain





4. Radiation Patterns

4.1 Test Setup

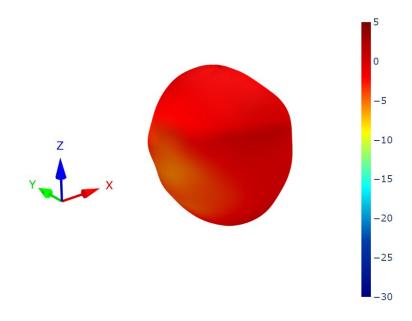


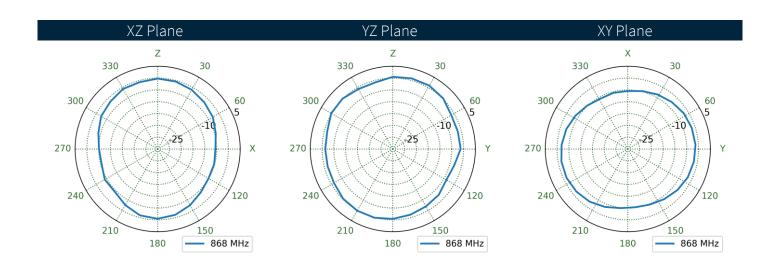




ILA.02 Patterns at 868 MHz

4.2





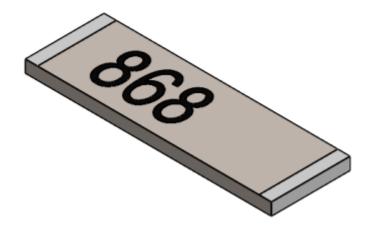


Mechanical Drawing





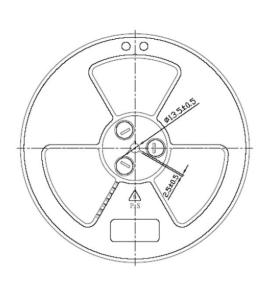


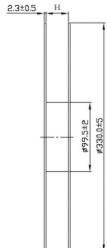




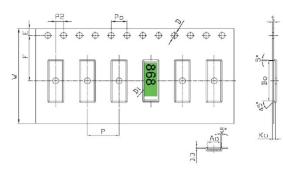
6. Packaging

6000 pcs ILA.02 reel Dimensions - 420*380mm Weight -1030g









Tape Dimensions(unit: mm)

Specifications	Tolerances
24.00	±0.30
8.00	±0.10
1.75	±0.10
11.50	±0.10
2.00	±0.10
1.50	+0.10
- 15 A	0.00
1.50	±0.10
4.00	±0.10
40.00	±0.20
	24.00 8.00 1.75 11.50 2.00 1.50 1.50 4.00

Pocket Dimensions(unit: mm)

Feature	Specifications	Tolerances
Ao	3.40	±0.10
Во	10.20	±0.10
Ko	0.70	±0.10
t	0.30	±0.05



6000 pcs ILA.02 reel Dimensions - 420*380mm Weight -1030g

6 reels, 36000pcs in one carton Carton Dimensions - 350*350*210mm Weight - 7Kg 210mm 350mm 350mm

1200mm

Pallet Dimensions 1200*1000*1460mm 36 Cartons per Pallet 6 Cartons per layer 6 Layers

1000mm



7. Antenna Integration Guide



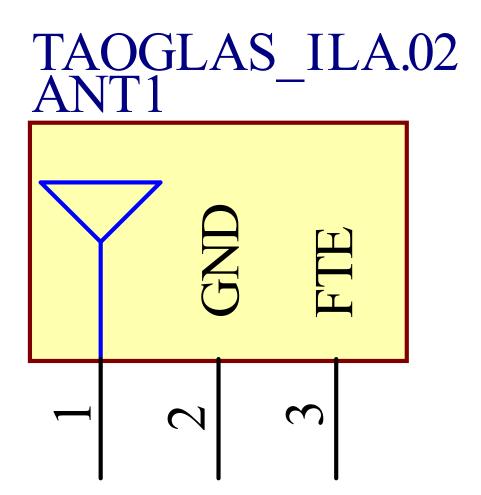




7.1 Schematic and Symbol Definition

The circuit symbol for the antenna is shown below. The antenna has 4 pins with all pins as functional.

Pin	Description
1	RF Feed
2	Ground
3	FTE (Fine Tuning Element





7.2 Antenna Integration

For any given PCB size, the antenna should ideally be placed on the PCB's longest side, to take advantage of the ground plane. Optimized matching components can be placed as shown.



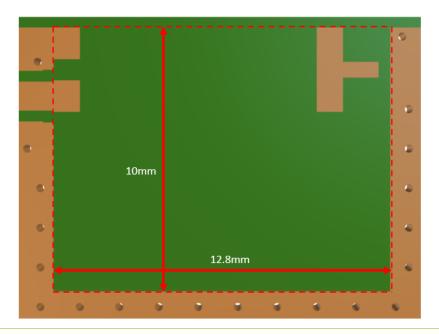
With Solder Mask



Without Solder Mask

7.3 PCB Clearance

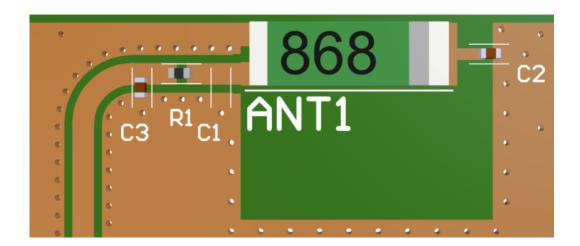
Below shows the antenna footprint and clearance through ALL layers on the PCB. Only the antenna pads and connections to feed and GND are present within this clearance area (marked RED). The clearance area extends to 10mm in length and 12.8mm in width from the centre of the PCBs board edge mechanical pads to the ground area. This clearance area includes the bottom side and ALL internal layers on the PCB.

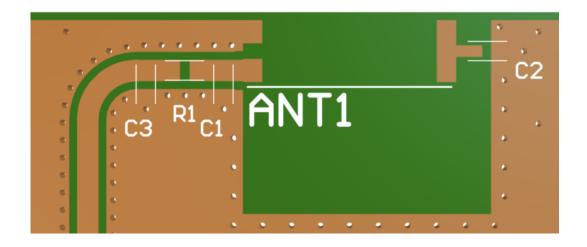




7.4 PCB Layout

The footprint and clearance on the PCB must meet the layout drawing in section 7.7. Note the placement of the optimized components. R1 is placed as close as possible to the RF feed (pad 1) in series connecting to ground. C3 is then placed tightly in parallel after that. C2 is placed close to the FTE (pad 3) as possible connecting to ground. C1 is an optional component but the footprint is recommended in case it is needed.







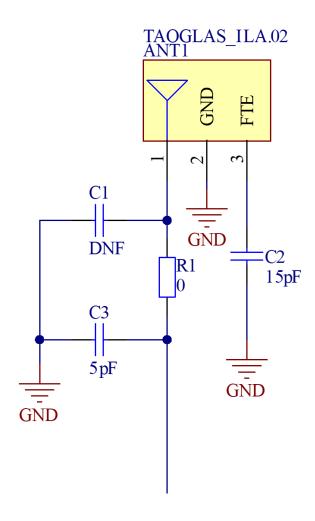
7.5 Evaluation Board





7.6 Evaluation Board Matching Circuit

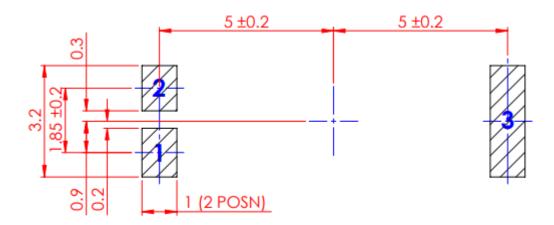
Matching components with the ILA.02 are recommended for the antenna to have optimal performance on the evaluation board, located in the spaces specified in previous sections. Additional matching components may be necessary for your device, so we recommend incorporating extra component footprints, forming a "pi" network, between the cellular module and the edge of the ground plane.



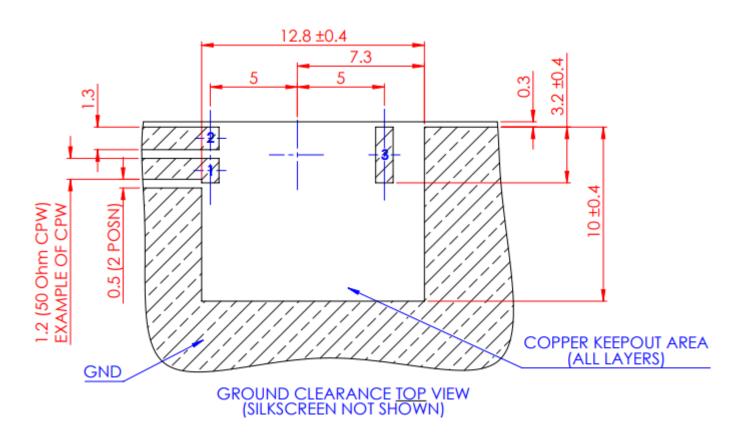
Designator	Туре	Value	Manufacturer	Manufacturer Part Number
R1	Resistor	0Ω	Yageo	RC0402JR-070RL
C1	Capacitor	Not Fitted	-	-
C2	Capacitor	15pF	Murata Electronics	GRM1555C1H150JA01D
C3	Capacitor	5pF	Murata Electronics	GRM1555C1H5R0CA01D



7.7 Footprint



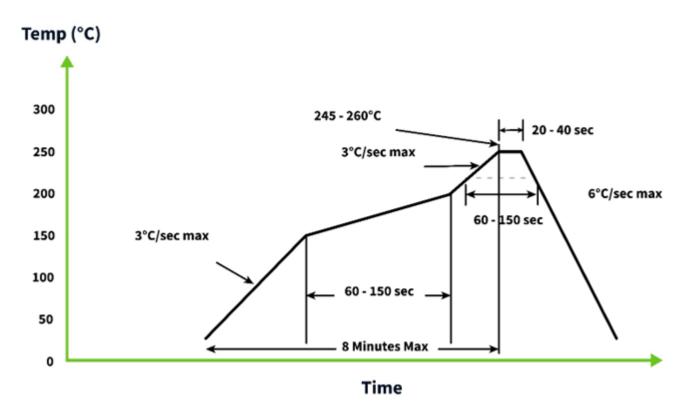
FOOTPRINT PCB





Solder Reflow Profile

The- can be assembled by following the recommended soldering temperatures are as follows:



*Temperatures listed within a tolerance of +/- 10º C

Smaller components are typically mounted on the first pass, however, we do advise mounting the- when placing larger components on the board during subsequent reflows.

Note: Soldering flux classified ROLO under IPC J-STD-004 is recommended.



Changelog for the datasheet

SPE-12-8-080- ILA.02

Revision: K (Current Version)		
Date:	2023-09-05	
Changes:	Updated Solder Reflow Information	
Changes Made by:	Cesar	

Previous Revisions

Revision: J		
Date:	2023-04-19	
Changes:	Full datasheet update	
Changes Made by:	Gary West	

Revision: E		
Date:	2017-04-21	
Changes:		
Changes Made by:	STAFF	

Revision: I		
Date:	2023-01-17	
Changes:	Updated image product	
Changes Made by:	Cesar Sousa	

Revision: D		
Date:	2016-09-12	
Changes:		
Changes Made by:	STAFF	

Revision: H		
Date:	2022-06-23	
Changes:	Updated graphs , radiation patterns and Antenna Installation Guide	
Changes Made by:	Evan Murphy	

Revision: C		
Date:	2014-08-19	
Changes:	EVB & Footprint	
Changes Made by:	AINE DOYLE	

Revision: G (Current Version)		
Date:	2021-10-28	
Changes:	Format Change, MSL	
Changes Made by:	Erik Landi	

Revision: B	
Date:	2012-06-27
Changes:	
Changes Made by:	STAFF

Revision: F		
Date:	2017-10-23	
Changes:	Packing drawing updated	
Changes Made by:	Carol Faughnan	

Revision: A (Original First Release)	
Date:	2012-05-08
Notes:	Initial Release
Author:	STAFF





www.taoglas.com

